

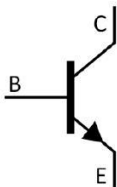
SOT-23

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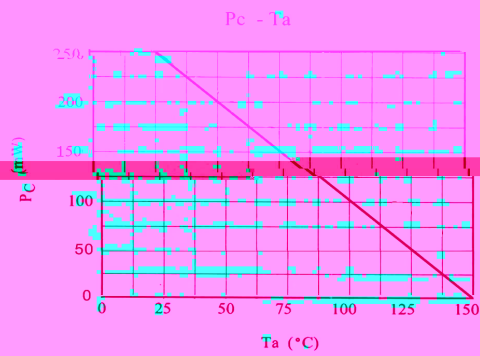
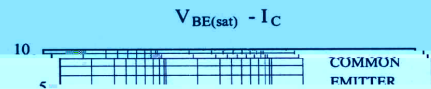
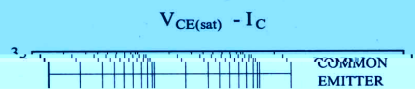
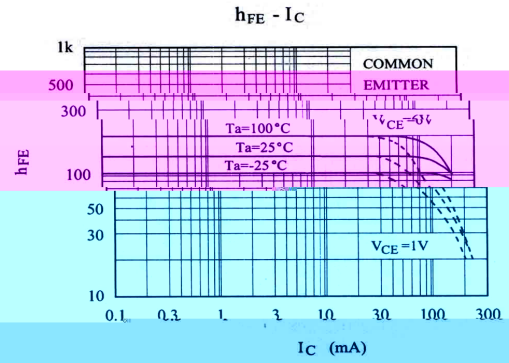
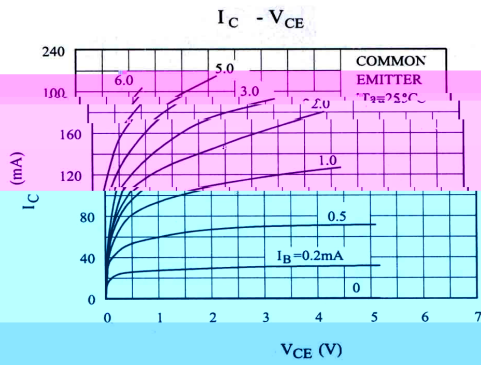


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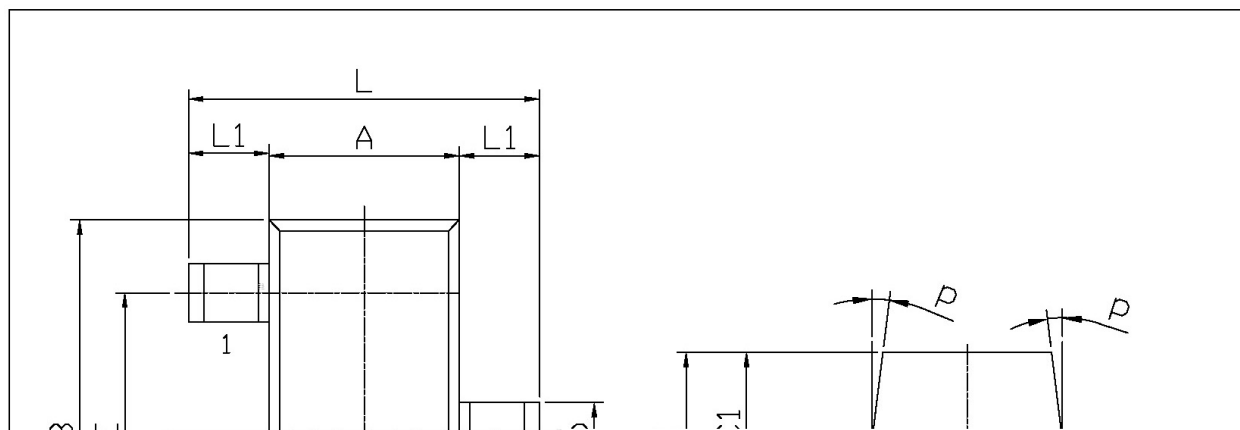
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|  |  |  | °C |

[illegible]

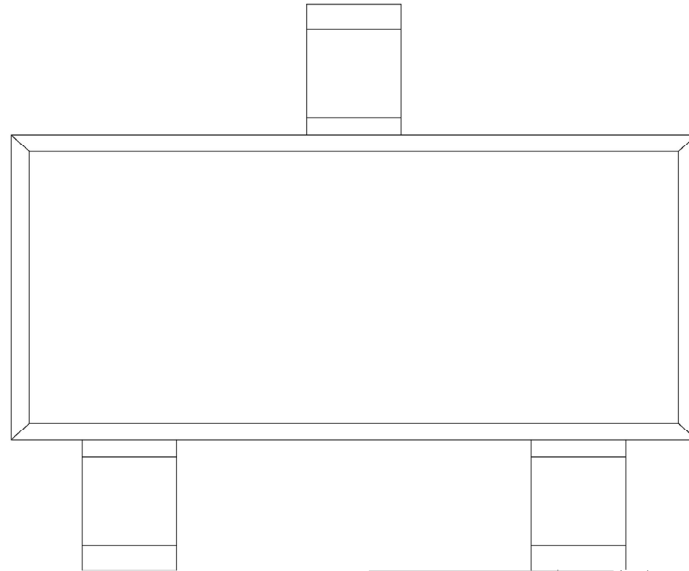


SOT-23

单位: mm



|    | MIN  | MAX  |    | MIN     | MAX  |
|----|------|------|----|---------|------|
| L  | 2.2  | 2.7  | C  | 1.30Max |      |
| L1 | 0.45 | 0.65 | C1 | 0.90    | 1.20 |
| A  | 1.15 | 1.50 | R  | 0.05    | 0.25 |
| B  | 2.70 | 3.10 | K  | 0       | 0.10 |
| E  | 1.70 | 2.10 | M  | 0.20MIN |      |
| E1 | 0.85 | 1.05 | P  | 7°      |      |
| b  | 0.35 | 0.55 |    |         |      |



H

HF

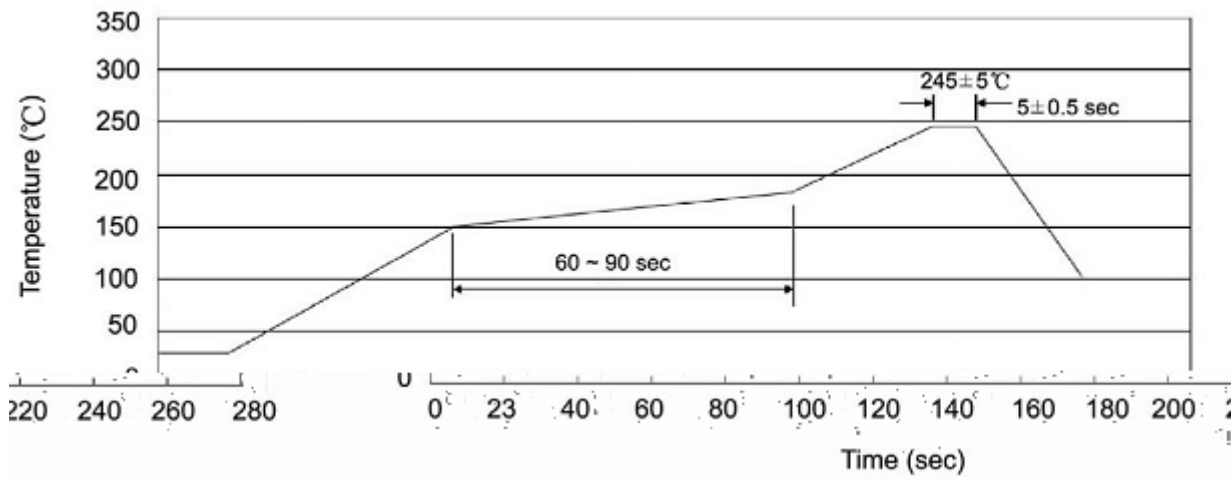
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Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

± ± ± ±

| 封装形式   | 包装数量               |                         |                        |                              |                        | 包装尺寸 |             |             |
|--------|--------------------|-------------------------|------------------------|------------------------------|------------------------|------|-------------|-------------|
|        | Units/Reel<br>只/卷盘 | Reels/Inner Box<br>卷盘/盒 | Units/Inner Box<br>只/盒 | Inner Boxes/Outer Box<br>盒/箱 | Units/Outer Box<br>只/箱 | Reel | Inner Box 盒 | Outer Box 箱 |
| SOT-23 | 3,000              | 10                      | 30,000                 | 6                            | 180,000                | 7 ×8 | 180×120×180 | 390×385×205 |